Unit in mm

TOSHIBA GTR MODULE SILICON N CHANNEL IGBT

MG75Q2YS40

HIGH POWER SWITCHING APPLICATIONS.

MOTOR CONTROL APPLICATIONS.

• High Input Impedance

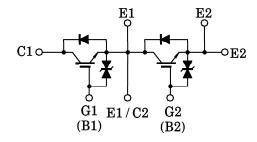
• High Speed : $t_f=0.5\mu s$ (Max.) $t_{rr}=0.5\mu s$ (Max.)

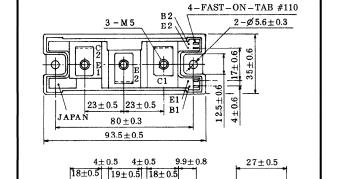
• Low Saturation Voltage

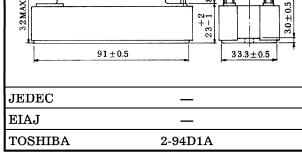
: $V_{CE(sat)} = 4.0V (Max.)$

- Enhancement-Mode
- Includes a Complete Half Bridge in One Package.
- The Electrodes are Isolated from Case.

EQUIVALENT CIRCUIT







Weight: 202g

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT	
Collector-Emitter Voltage		v_{CES}	1200	V	
Gate-Emitter Voltage		v_{GES}	±20	V	
Collector Current	DC	$I_{\mathbf{C}}$	75	- A	
	1ms	I_{CP}	150		
Forward Current	DC	$I_{\mathbf{F}}$	75	A	
	1ms	$I_{\mathbf{FM}}$	150		
Collector Power Dissipation (Tc=25°C)		PC	560	w	
Junction Temperature		$\mathrm{T_{j}}$	150	°C	
Storage Temperature Range		$\mathrm{T_{stg}}$	-40~125	$^{\circ}\mathrm{C}$	
Isolation Voltage		V_{Isol}	2500 (AC 1 minute)	V	
Screw Torque (Terminal / Mounting)		_	3/3	N·m	

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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		IGES	$V_{GE} = \pm 20V, V_{CE} = 0$			±10	μ A
Collector Cut-off Current		I_{CES}	$V_{CE} = 1200V, V_{GE} = 0$			1.0	mA
Gate-Emitter Cut-off Voltage		$v_{GE(OFF)}$	$I_C = 75 \text{mA}, V_{CE} = 5 \text{V}$	3.0	I	6.0	V
Collector-Emitter Saturation Voltage		V _{CE(sat)}	$I_{C} = 75A, V_{GE} = 15V$	1	3.0	4.0	V
Input Capacitance		Cies	$V_{\text{CE}} = 10\text{V}, V_{\text{GE}} = 0$ f=1MHz	_	9000	_	рF
Switching Time	Rise Time	$\mathbf{t_r}$		1	0.3	0.6	μs
	Turn-on Time	t_{on}		ı	0.4	0.8	
	Fall Time	t_f	[0 1 L 1 ,]	1	0.2	0.5	
	Turn-off Time	$t_{ m off}$	-15V $600V$	_	0.8	1.5	
Forward Voltage VF		$ m V_{ m F}$	$I_{F} = 75A, V_{GE} = 0$	_	2.0	3.0	V
Reverse Recovery Time t _{rr}		t _{rr}	$I_F = 75A, V_{GE} = -10V$ di / dt = 100A / μs	_	0.25	0.5	μs
Thermal Resistance		R _{th(j-c)}	Transistor		_	0.22	°C/W
			Diode			0.8	

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